Technical Specifications of Acoustic Emission Sensors and set up

1.0 Bidder Eligibility Criteria:

I	Bidder Eligibility Criteria-I (Public Procurement – Preference to Make in India)	Class I / Class II	Local Content value	Reference, Page No.
I	Only 'Class-I local suppliers' and 'Class-II local suppliers', as defined under DIPP, MoCI Order No. P-45021/2/2017-PP (BE II) dated 16 th September 2020 and other subsequent orders issued therein.			
2.0	Bidder Eligibility Criteria-II	Complied/Not Complied	Reference Page No.	Remarks, If any
1	The supplier/vendor must be an original equipment manufacturer or an authorized agent/dealer/seller of the item. The vendor should have supplied at least 5 similar units at other IITs or NITs, or national laboratories and research centres (DRDO/CSIR/BARC/IGCAR), or R&D centres of reputed multinational companies, or globally recognized universities, in the last 5 years. PO copy, or performance certificate, along with contact details (for these organizations) needs to be submitted.			

3.0 Technical Compliance:

Equipment feature:

AE set-up comprising of AE data acquisition system and AE sensors must be able to capture and store the real-time AE signal time and frequency data of the specimen/structure under loading.

Sl.No.	Specifications	Feature	Complied/Not Complied	Reference Page No.
Technic	Technical Specifications:			
1.	AE acquisition channel requirements	Minimum 8 AE acquisition channels with the provision for expansion in the future.		
2.		Minimum 8 waveforms acquisition/transient recorder channels with the provision for expansion in the future.		
3.		Minimum 8 number of parametric acquisition channels		
4.	AE board	Bus architecture: signal processing board must have been built over PCI express bus architecture for maximum acquisition speed.		
5.	specifications & analog signal processing	Board integration: 8-channels for AE time parameters, 8-channels for waveform acquisition and minimum 4 channels for other output parameter [e.g. temperature, pressure]		

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		acquisition should be built in on single PCI	
		express board to make system extremely	
		portable.	
6.		Analog bandwidth (frequency response):	
		1kHz-1mHz	
7.		Analog filters options in software: Analog	
' '		high pass computer selectable 2nd order	
		active butterworth filters: 1 kHz, 5 MHz, 20	
		kHz, 100 kHz; Analog low pass computer	
		selectable 2nd order active butterworth	
		filters:100 kHz, 400 kHz, 1MHZ	
8.		Bus architecture: signal processing board	
		must have been built over PCI express bus	
		architecture for maximum acquisition speed.	
9.		Analog to Digital Converter (ADC) type:	
_ ·		Minimum 16-bit with a sample rate of	
		minimum 10 msps (mega samples per second)	
10.		Digital data processing: minimum 18 bit with	
10.			
1 1		a sample rate of 10 msps	
11.		AE time parameters: Time of first threshold	
	Digital Signal	crossing, Time of the test, Pac-energy, Signal	
	Processing	strength, True energy, Peak amplitude, Rise	
		time, Duration, Counts, Counts to peak, Root	
		Mean Square (RMS), Average signal level	
		(ASL), Threshold, Parametric, Average	
		frequency	
12.			
14.		Extracted AE fraguency based features	
		Extracted AE frequency-based features:	
		frequency centroid, peak frequency	
13.		Analog inpute: Minimum 04 nor hourd	
		Analog inputs:Minimum 04 per board	
14.		Lamest non-goal / 10 10 11 - 1	
	Decirable narameteries	Input range:+/- 10 volts on all channels	
15.	Desirable parameterics	B 1.1 1611	
	inputs	Resolution: 16-bit	
16.		Provide quotation for additional software	
10.		licenses (in case of lost dongle, credentials	
		etc.)	
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17.		Minimum channel capacity of 32	
		PC BUS: PCI Express,	
		Passive backplane computer	
	N/L	PROCESSOR: Intel Core i7 processor	
	Monitoring system	•	
		RAM: 16 GB MINIMUM	
		HD: 1TB SSD	
		OS: WIN-10, Keyboard, Mouse, and	
10		24" LED Monitor	
18.		Software must perform simultaneous AE	
		hits/events & waveform capture.	
19.		Software should include linear & zonal	
19.			
		location capabilities, Wavelet analysis,	
		Dispersion curves, Spectrogram & short time	
		fft	

20.	Real-time data acquisition & analysis software	Software should contain both 2-D planar and 3-D location modules		
21.	AE sensors and	Minimum 9 AE sensors with integral preamplifier is required. Sensors should have the following features: Resonant frequency: 50 to 60 khz; Operational frequency: 30khz – 100 khz; Peak sensitivity ref v/ (m/s): 105 db minimum; Temp range: -35 to 80 deg. C; Dimensions: diameter less than 30 mm; Connector: SMA or BNC		
22.	accessories	Power/signal cables: Minimum 9 cables of 10 m in length with BNC/SMA connectors		
23.		Magnetic hold downs for AE sensors for the number of sensors specified.		
24.		Printed manual for AE system and software.		
25.		Minimum 2 years.		
26.		Optional Quote-1: Additional 2 years		
27.	Warranty:	warranty may be quoted separately Optional Quote-2: AMC beyond 2 Years Warranty period		
28.		(Optional quotes will not be taken up for price bid comparison)		
Other Terms and Conditions				
1.	The system should be deli	vered within 14-16 weeks from the opening of		
		of the purchase order, whichever is later.		
2.	Costs and related information should be given only in the financial bid.			
3.	The cost should include all delivery costs up to IIT Madras. The warranty shall commence only from the date of equipment			
4.	installation at IITM.			
5.	Prices quoted should be valid for at least 120 days.			
6.	Item-wise break up of cost should be provided in the commercial bid for			
	optional items and accessories. IIT Madras reserves the right to exclude some items from the purchase.			
7.	As part of tender technical evaluation, IIT Madras will approach the past end users for feedback and in case of any adverse feedback the bidder will be technically disqualified.			
8.	The system should be installed and commissioned with no additional cost.			
9.	Training at IIT Madras should be provided with no additional cost.			
10.	System manual should be provided in CD or pen drive form.			
11.	Services and spares should be necessarily available within India.			

Technical Bid should comprise of the following		Complied/Not Complied	Reference Page No.
1.	Detailed Technical brochure		g
2.	Detailed technical write up explaining how each of the Technical Specifications are complied with, indicating the location in the brochure		
3.	The vendor should guarantee round the clock technical support not only during the warranty period but even beyond through an annual maintenance contract. Demonstration of having provided such satisfactory technical support to customers shall be enclosed with the technical bid.		
4.	The manufacturer must have a well-qualified technical support team		

(Note: It is mandatory for the bidders to provide the compliance statement in tabular column format along with catalogue page number (comply/not comply) for the Above points with document proof as required. Failing which bidders will be technically disqualified)